INTEGRATED CIRCUITS

DATA SHEET

74HC/HCT123
Dual retriggerable monostable multivibrator with reset

Product specification

Supersedes data of September 1993

File under Integrated Circuits, IC06

1998 Jul 08

Philips
Semiconductors

PHILIPS

PHILIPS

Dual retriggerable monostable multivibrator with reset

74HC/HCT123

FEATURES

- DC triggered from active HIGH or active LOW inputs
- Retriggerable for very long pulses up to 100% duty factor
- Direct reset terminates output pulse
- Schmitt-trigger action on all inputs except for the reset input
- Output capability: standard (except for nR_{EXT}/C_{EXT})
- I_{CC} category: MSI

GENERAL DESCRIPTION

The 74HC/HCT123 are high-speed Si-gate CMOS devices and are pin compatible with low power Schottky TTL (LSTTL). They are specified in compliance with JEDEC standard no. 7A.

The 74HC/HCT123 are dual retriggerable monostable multivibrators with output pulse width control by three methods. The basic pulse time is programmed by selection of an external resistor (R_{EXT}) and capacitor (C_{EXT}). The external resistor and capacitor are normally connected as shown in Fig.6.

Once triggered, the basic output pulse width may be extended by retriggering the gated active LOW-going edge input ($n\overline{A}$) or the active HIGH-going edge input (nB). By repeating this process, the output pulse period (nQ = HIGH, $n\overline{Q}$ = LOW) can be made as long as desired. Alternatively an output delay can be terminated at any time by a LOW-going edge on input $n\overline{R}_D$, which also inhibits the triggering.

An internal connection from $n\overline{R}_D$ to the input gates makes it possible to trigger the circuit by a positive-going signal at input $n\overline{R}_D$ as shown in the function table. Figures 7 and 8 illustrate pulse control by retriggering

and early reset. The basic output pulse width is essentially determined by the values of the external timing components R_{EXT} and C_{EXT}. For pulse widths, when $C_{EXT} < 10\,000$ pF, see Fig.9.

When $C_{EXT} > 10\,000$ pF, the typical output pulse width is defined as:

$t_W = 0.45 \times R_{EXT} \times C_{EXT}$ (typ.),

where:

t_W = pulse width in ns;
R_{EXT} = external resistor in kΩ;
C_{EXT} = external capacitor in pF.

Schmitt-trigger action in the $n\overline{A}$ and nB inputs, makes the circuit highly tolerant to slower input rise and fall times.

The '123' is identical to the '423' but can be triggered via the reset input.

QUICK REFERENCE DATA

GND = 0 V; T_{amb} = 25 °C; t_r = t_f = 6 ns

SYMBOL	PARAMETER	CONDITIONS	TYPICAL		UNIT
			HC	HCT	
t_{PHL}/ t_{PLH}	propagation delay $n\overline{A}$, nB to nQ, $n\overline{Q}$	C_L = 15 pF; V_{CC} = 5 V; R_{EXT} = 5 kΩ; C_{EXT} = 0 pF	26	26	ns
	$n\overline{R}_D$ to nQ, $n\overline{Q}$		20	23	ns
C_I	input capacitance		3.5	3.5	pF
C_{PD}	power dissipation capacitance per monostable	notes 1 and 2	54	56	pF

Notes

1. C_{PD} is used to determine the dynamic power dissipation (P_D in μW):

   $P_D = C_{PD} \times V_{CC}^2 \times f_i + \Sigma(C_L \times V_{CC}^2 \times f_o) + 0.75 \times C_{EXT} \times V_{CC}^2 \times f_o + D \times 16 \times V_{CC}$ where:

   f_i = input frequency in MHz
   f_o = output frequency in MHz
   D = duty factor in %
   C_L = output load capacitance in pF
   V_{CC} = supply voltage in V
   C_{EXT} = timing capacitance in pF
   $\Sigma (C_L \times V_{CC}^2 \times f_o)$ sum of outputs

2. For HC   the condition is V_I = GND to V_{CC}
   For HCT the condition is V_I = GND to V_{CC} − 1.5 V

Dual retriggerable monostable multivibrator with reset

74HC/HCT123

ORDERING INFORMATION

TYPE NUMBER	PACKAGE		
	NAME	DESCRIPTION	VERSION
74HC123N; 74HCT123N	DIP16	plastic dual in-line package; 16 leads (300 mil); long body	SOT38-1
74HC123D; 74HCT123D	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1
74HC123DB; 74HCT123DB	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1
74HC123PW; 74HCT123PW	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1

PIN DESCRIPTION

PIN NO.	SYMBOL	NAME AND FUNCTION
1, 9	$1\overline{A}$, $2\overline{A}$	trigger inputs (negative-edge triggered)
2, 10	1B, 2B	trigger inputs (positive-edge triggered)
3, 11	$1\overline{R}_D$, $2\overline{R}_D$	direct reset LOW and trigger action at positive edge
4, 12	$1\overline{Q}$, $2\overline{Q}$	outputs (active LOW)
7	$2R_{EXT}/C_{EXT}$	external resistor/capacitor connection
8	GND	ground (0 V)
13, 5	1Q, 2Q	outputs (active HIGH)
14, 6	$1C_{EXT}$, $2C_{EXT}$	external capacitor connection
15	$1R_{EXT}/C_{EXT}$	external resistor/capacitor connection
16	V_{CC}	positive supply voltage

Fig.1 Pin configuration.

Fig.2 Logic symbol.

Fig.3 IEC logic symbol.

Dual retriggerable monostable multivibrator with reset

74HC/HCT123

Fig.4 Functional diagram.
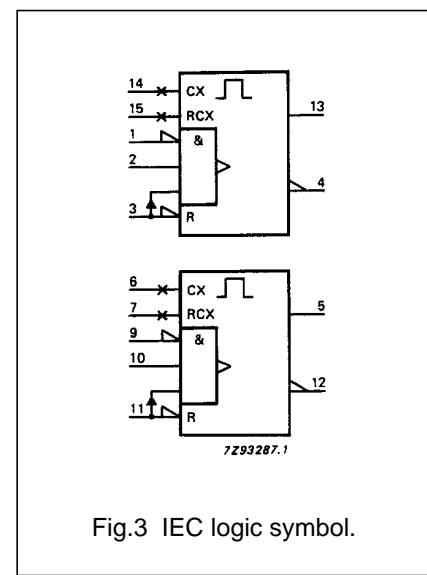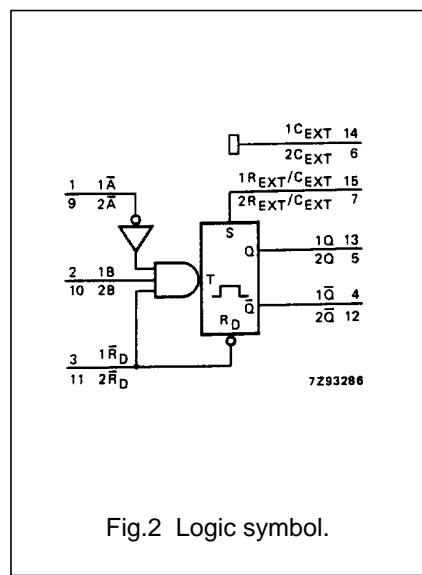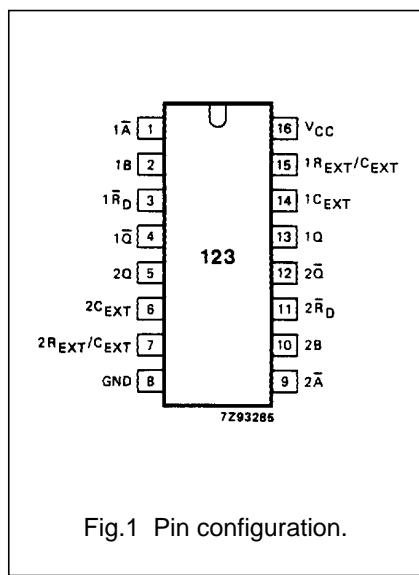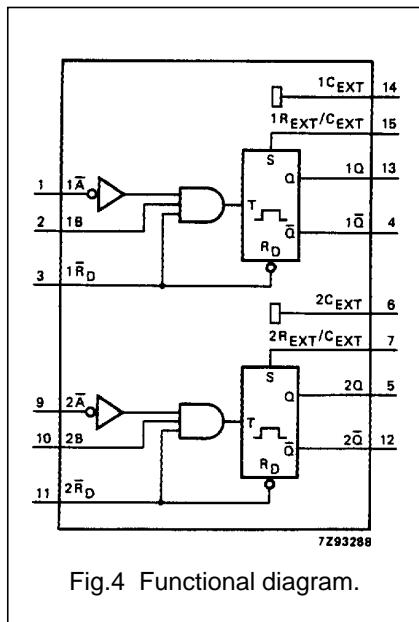
FUNCTION TABLE

INPUTS			OUTPUTS	
$n\overline{R}_D$	$n\overline{A}$	nB	nQ	$n\overline{Q}$
L	X	X	L	H
X	H	X	L[1]	H[1]
X	X	L	L[1]	H[1]
H	L	↑	⊓	⊔
H	↓	H	⊓	⊔
↑	L	H	⊓	⊔

Note

1. If the monostable was triggered before this condition was established, the pulse will continue as programmed.

H	= HIGH voltage level
L	= LOW voltage level
X	= don't care
↑	= LOW-to-HIGH transition
↓	= HIGH-to-LOW transition
⊓	= one HIGH level output pulse
⊔	= one LOW level output pulse

(1) For minimum noise generation, it is recommended to ground pins 6 ($2C_{EXT}$) and 14 ($1C_{EXT}$) externally to pin 8 (GND).

Fig.5 Logic diagram.
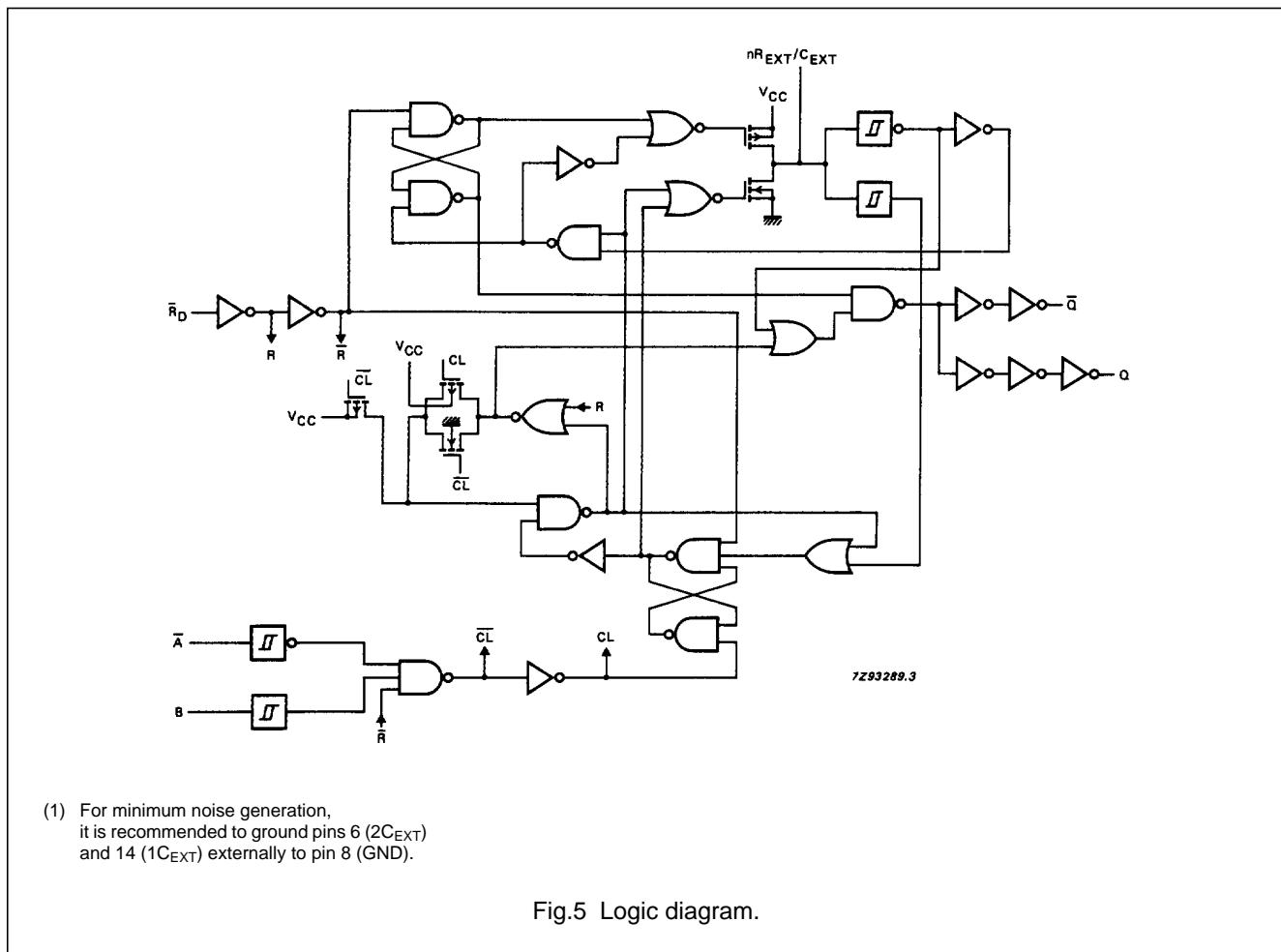
Dual retriggerable monostable
multivibrator with reset

74HC/HCT123
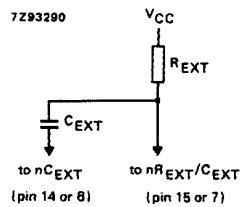
Fig.6 Timing component connections.

DC CHARACTERISTICS FOR 74HC

For the DC characteristics see *"74HC/HCT/HCU/HCMOS Logic Family Specifications"*.

Output capability: standard (except for nR_{EXT}/C_{EXT})
I_{CC} category: MSI

## Dual retriggerable monostable multivibrator with reset

74HC/HCT123

AC CHARACTERISTICS FOR 74HC

GND = 0 V; $t_r = t_f$ = 6 ns; C_L = 50 pF

SYMBOL	PARAMETER	T_{amb} (°C)							UNIT	V_{CC} (V)	TEST CONDITIONS WAVEFORMS/ NOTES
		74HC									
		+25			−40 to +85		−40 to +125				
		min.	typ.	max.	min.	max.	min.	max.			
t_{PLH}	propagation delay $n\overline{R}_D$, $n\overline{A}$, nB to $n\overline{Q}$		83 30 24	255 51 43		320 64 54		385 77 65	ns	2.0 4.5 6.0	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ
t_{PLH}	propagation delay $n\overline{R}_D$, $n\overline{A}$, nB to nQ		83 30 24	255 51 43		320 64 54		385 77 65	ns	2.0 4.5 6.0	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ
t_{PHL}	propagation delay $n\overline{R}_D$ to nQ (reset)		66 24 19	215 43 37		270 54 46		325 65 55	ns	2.0 4.5 6.0	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ
t_{PLH}	propagation delay $n\overline{R}_D$ to $n\overline{Q}$ (reset)		66 24 19	215 43 37		270 54 46		325 65 55	ns	2.0 4.5 6.0	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ
t_{THL} / t_{TLH}	output transition time		19 7 6	75 15 13		95 19 16		110 22 19	ns	2.0 4.5 6.0	
t_W	trigger pulse width $n\overline{A}$ = LOW	100 20 17	8 3 2		125 25 21		150 30 26		ns	2.0 4.5 6.0	Fig.7
t_W	trigger pulse width nB = HIGH	100 20 17	17 6 5		125 25 21		150 30 26		ns	2.0 4.5 6.0	Fig.7
t_W	reset pulse width $n\overline{R}_D$ = LOW	100 20 17	14 5 4		125 25 21		150 30 26		ns	2.0 4.5 6.0	Fig.8
t_W	output pulse width nQ = HIGH $n\overline{Q}$ = LOW		450		−	−			μs	5.0	C_{EXT} = 100 nF; R_{EXT} = 10 kΩ; Figs 7 and 8
t_W	output pulse width nQ = HIGH $n\overline{Q}$ = LOW		75		−	−			ns	5.0	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ; note 1; Figs 7 and 8
t_{rt}	retrigger time $n\overline{A}$, nB		110		−	−			ns	5.0	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ; note 2; Fig.7
R_{EXT}	external timing resistor	10 2		1000 1000	−		−		kΩ	2.0 5.0	Fig.9
C_{EXT}	external timing capacitor	no limits							pF	5.0	Fig.9; note 3

DC CHARACTERISTICS FOR 74HCT

For the DC characteristics see *"74HC/HCT/HCU/HCMOS Logic Family Specifications"*.

Output capability: standard (except for nR_{EXT} / C_{EXT})
I_{CC} category: MSI

Note to HCT types

The value of additional quiescent supply current (ΔI_{CC}) for a unit load of 1 is given in the family specifications.
To determine ΔI_{CC} per input, multiply this value by the unit load coefficient shown in the table below.

INPUT	UNIT LOAD COEFFICIENT
$n\overline{A}$, nB	0.35
$n\overline{R}_D$	0.50

Dual retriggerable monostable multivibrator with reset

74HC/HCT123

AC CHARACTERISTICS FOR 74HCT

GND = 0 V; t_r = t_f = 6 ns; C_L = 50 pF

SYMBOL	PARAMETER	T_{amb} (°C)						UNIT	TEST CONDITIONS	
		74HCT							V_{CC} (V)	WAVEFORMS/ NOTES
		+25			−40 to +85		−40 to +125				
		min.	typ.	max.	min.	max.	min.	max.			
t_{PHL}	propagation delay $n\overline{R}_D$, $n\overline{A}$, nB to $n\overline{Q}$		30	51		64		77	ns	4.5	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ
t_{PLH}	propagation delay $n\overline{R}_D$, $n\overline{A}$, nB to nQ		28	51		64		77	ns	4.5	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ
t_{PHL}	propagation delay $n\overline{R}_D$ to nQ (reset)		27	46		58		69	ns	4.5	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ
t_{PLH}	propagation delay $n\overline{R}_D$ to $n\overline{Q}$ (reset)		23	46		58		69	ns	4.5	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ
t_{THL} / t_{TLH}	output transition time		7	15		19		22	ns	4.5	
t_W	trigger pulse width $n\overline{A}$ = LOW	20	3		25		30		ns	4.5	Fig.7
t_W	trigger pulse width nB = HIGH	20	5		25		30		ns	4.5	Fig.7
t_W	reset pulse width $n\overline{R}_D$ = LOW	20	7		25		30		ns	4.5	Fig.8
t_W	output pulse width nQ = HIGH $n\overline{Q}$ = LOW		450		–	–	–	–	μs	5.0	C_{EXT} = 100 nF; R_{EXT} = 10 kΩ; Figs 7 and 8
t_W	output pulse width nQ = HIGH $n\overline{Q}$ = LOW		75		–	–	–	–	ns	5.0	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ; note 1; Figs 7 and 8
t_{rt}	retrigger time $n\overline{A}$, nB		110		–	–	–	–	ns	5.0	C_{EXT} = 0 pF; R_{EXT} = 5 kΩ; note 2; Fig.7
R_{EXT}	external timing resistor	2		1000	–	–	–	–	kΩ	5.0	Fig.9
C_{EXT}	external timing capacitor	no limits							pF	5.0	Fig.9; note 3

Dual retriggerable monostable
multivibrator with reset

74HC/HCT123

Notes to AC characteristics

1. For other R_{EXT} and C_{EXT} combinations see Fig.9.
   If $C_{EXT} > 10$ nF, the next formula is valid:

   $$t_W = K \times R_{EXT} \times C_{EXT} \text{ (typ.)}$$

   where: t_W = output pulse width in ns;
   R_{EXT} = external resistor in kΩ; C_{EXT} = external capacitor in pF;
   K   = constant = 0.55 for $V_{CC} = 5.0$ V and 0.48 for $V_{CC} = 2.0$ V.

   The inherent test jig and pin capacitance at pins 15 and 7 (nR_{EXT} / C_{EXT}) is approximately 7 pF.

2. The time to retrigger the monostable multivibrator depends on the values of R_{EXT} and C_{EXT}.
   The output pulse width will only be extended when the time between the active-going edges of the trigger input pulses meets the minimum retrigger time.
   If $C_{EXT} > 10$ pF, the next formula (at $V_{CC} = 5.0$ V) for the set-up time of a retrigger pulse is valid:

   $$t_{rt} = 30 + 0.19 \times R_{EXT} \times C_{EXT}^{0.9} + 13 \times R_{EXT}^{1.05} \text{ (typ.)}$$

   where: t_{rt} = retrigger time in ns;
   C_{EXT} = external capacitor in pF;
   R_{EXT} = external resistor in kΩ.

   The inherent test jig and pin capacitance at pins 15 and 7 (nR_{EXT} / C_{EXT}) is 7 pF.

3. When the device is powered-up, initiate the device via a reset pulse, when $C_{EXT} < 50$ pF.

Dual retriggerable monostable
multivibrator with reset

74HC/HCT123

AC WAVEFORMS
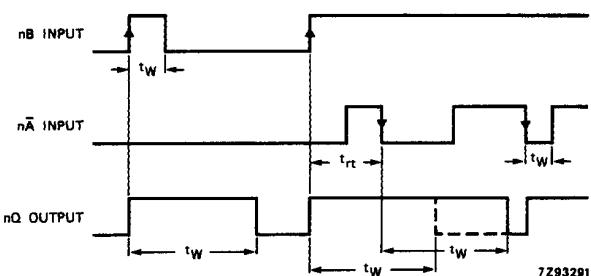

Fig.7   Output pulse control using retrigger pulse;
nR̄D = HIGH.
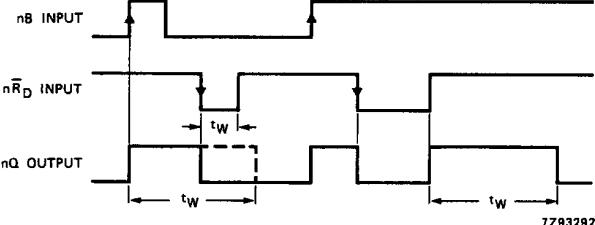
Fig.8   Output pulse control using reset input in nR̄D;
nĀ = LOW.
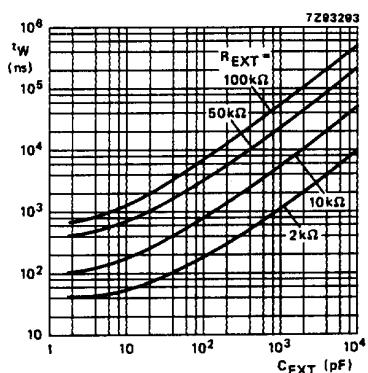
Fig.9   Typical output pulse width as a function of the
external capacitor values at V_{CC} = 5.0 V and
T_{amb} = 25 °C.
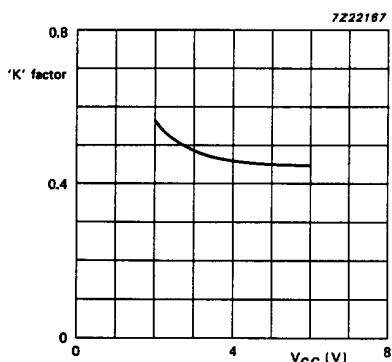
Fig.10   HCT typical "k" factor as a function of V_{CC};
C_X = 10 nF; R_X = 10 kΩ to 100 kΩ.

APPLICATION INFORMATION

Power-up considerations

When the monostable is powered-up it may produce an
output pulse, with a pulse width defined by the values of R_X
and C_X, this output pulse can be eliminated using the
circuit shown in Fig.11.
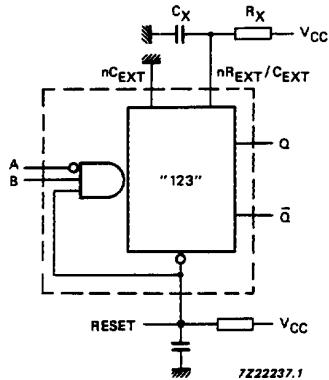
Fig.11 Power-up output pulse elimination circuit.

Power-down considerations

A large capacitor (C_X) may cause problems when
powering-down the monostable due to the energy stored
in this capacitor. When a system containing this device is
powered-down or a rapid decrease of V_{CC} to zero occurs,
the monostable may substain damage, due to the
capacitor discharging through the input protection diodes.
To avoid this possibility, use a damping diode (D_X)
preferably a germanium or Schottky type diode able to
withstand large current surges and connect as shown in
Fig.12
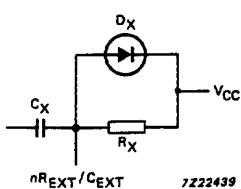
Fig.12 Power-down protection circuit.

Dual retriggerable monostable
multivibrator with reset

74HC/HCT123

PACKAGE OUTLINES

DIP16: plastic dual in-line package; 16 leads (300 mil); long body

SOT38-1

scale
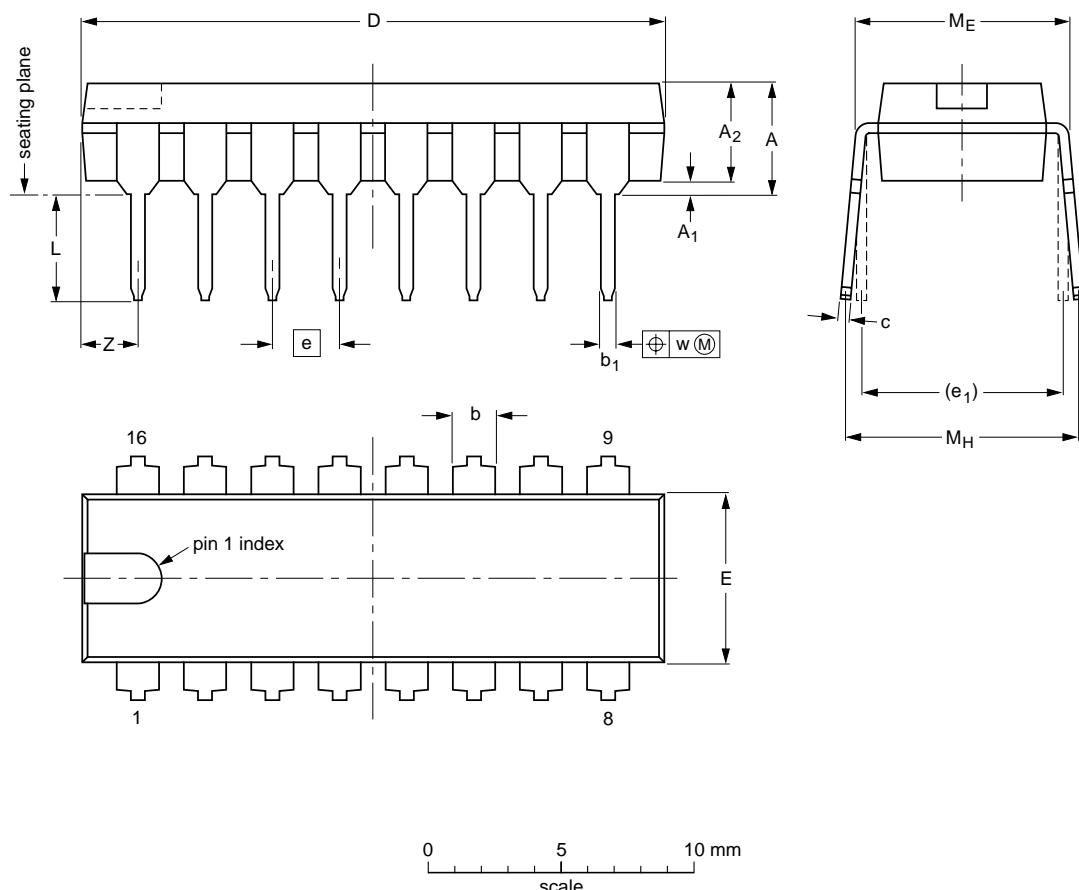
DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A₁ min.	A₂ max.	b	b₁	c	D [1]	E [1]	e	e₁	L	Mₑ	M_H	w	Z [1] max.
mm	4.7	0.51	3.7	1.40 1.14	0.53 0.38	0.32 0.23	21.8 21.4	6.48 6.20	2.54	7.62	3.9 3.4	8.25 7.80	9.5 8.3	0.254	2.2
inches	0.19	0.020	0.15	0.055 0.045	0.021 0.015	0.013 0.009	0.86 0.84	0.26 0.24	0.10	0.30	0.15 0.13	0.32 0.31	0.37 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-1	050G09	MO-001AE				92-10-02 95-01-19

Dual retriggerable monostable multivibrator with reset

74HC/HCT123

SO16: plastic small outline package; 16 leads; body width 3.9 mm
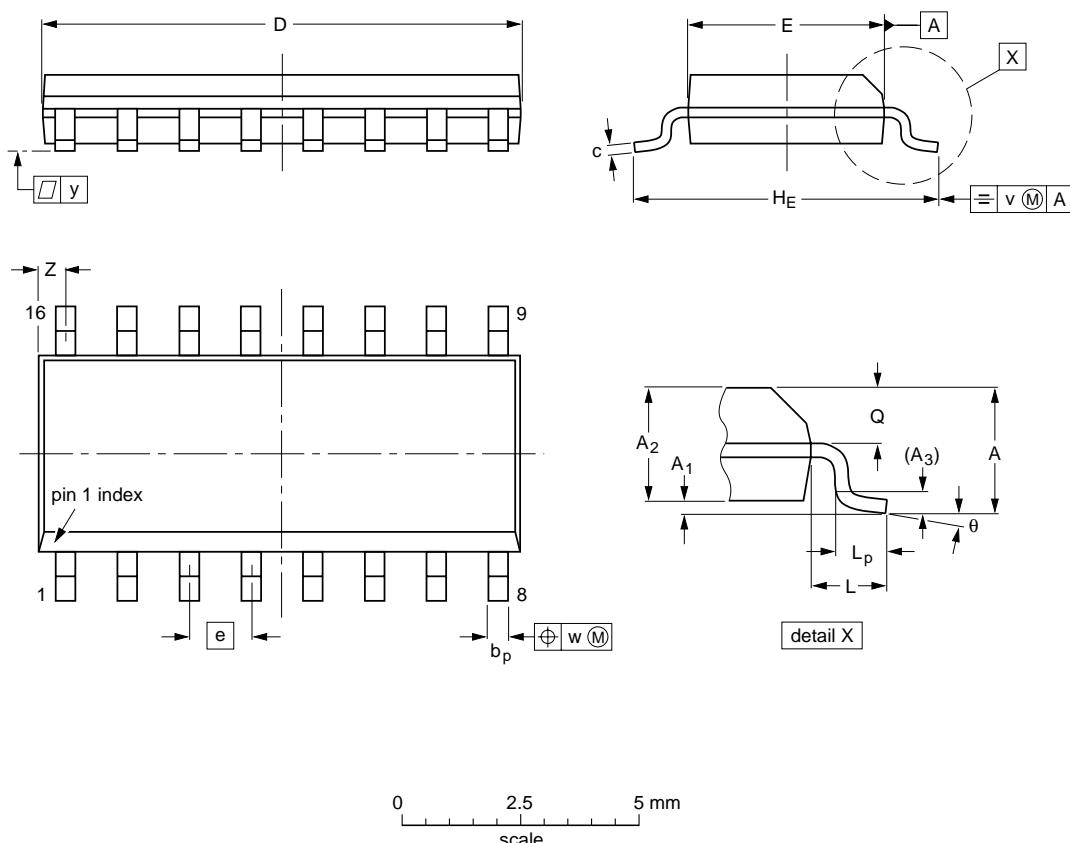
SOT109-1


```
0        2.5      5 mm
├─┴─┴─┴─┴─┴─┴─┴─┴─┤
        scale
```

DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A₁	A₂	A₃	bₚ	c	D⁽¹⁾	E⁽¹⁾	e	Hₑ	L	Lₚ	Q	v	w	y	Z⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.39 0.38	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT109-1	076E07S	MS-012AC				~~95-01-23~~ 97-05-22

Dual retriggerable monostable
multivibrator with reset

74HC/HCT123

SSOP16: plastic shrink small outline package; 16 leads; body width 5.3 mm

SOT338-1

detail X
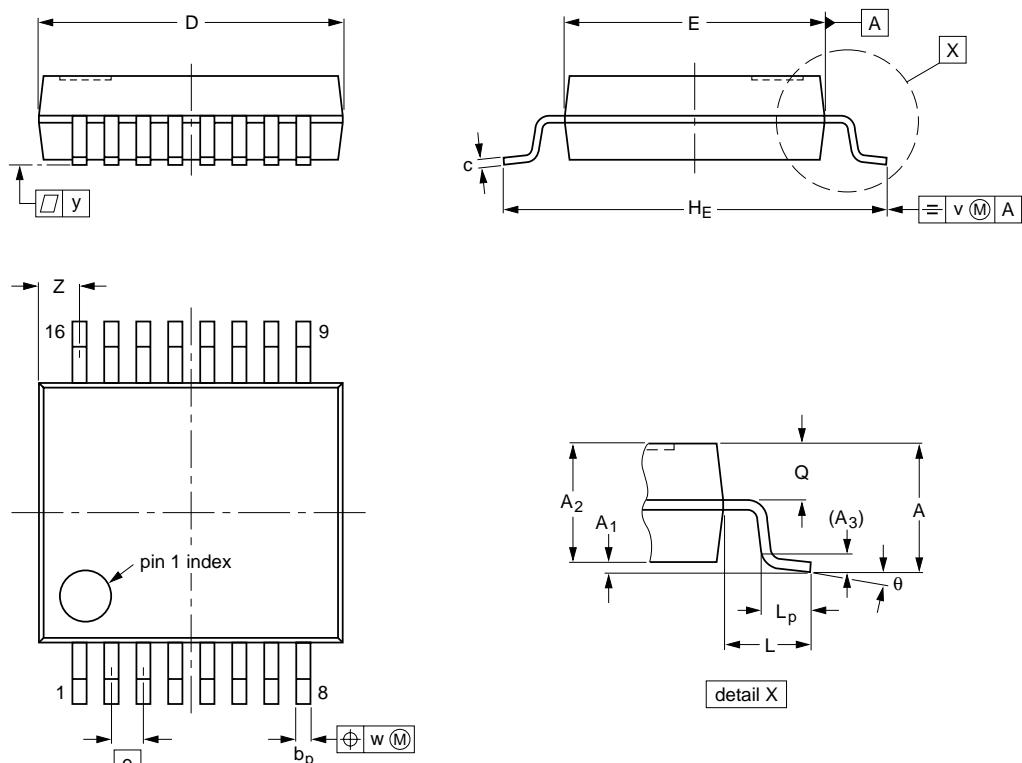
DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_1	A_2	A_3	b_p	c	$D^{(1)}$	$E^{(1)}$	e	H_E	L	L_p	Q	v	w	y	$Z^{(1)}$	θ
mm	2.0	0.21 0.05	1.80 1.65	0.25	0.38 0.25	0.20 0.09	6.4 6.0	5.4 5.2	0.65	7.9 7.6	1.25	1.03 0.63	0.9 0.7	0.2	0.13	0.1	1.00 0.55	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

| OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT338-1		MO-150AC				~~94-01-14~~ 95-02-04

Dual retriggerable monostable
multivibrator with reset

74HC/HCT123

TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm   **SOT403-1**
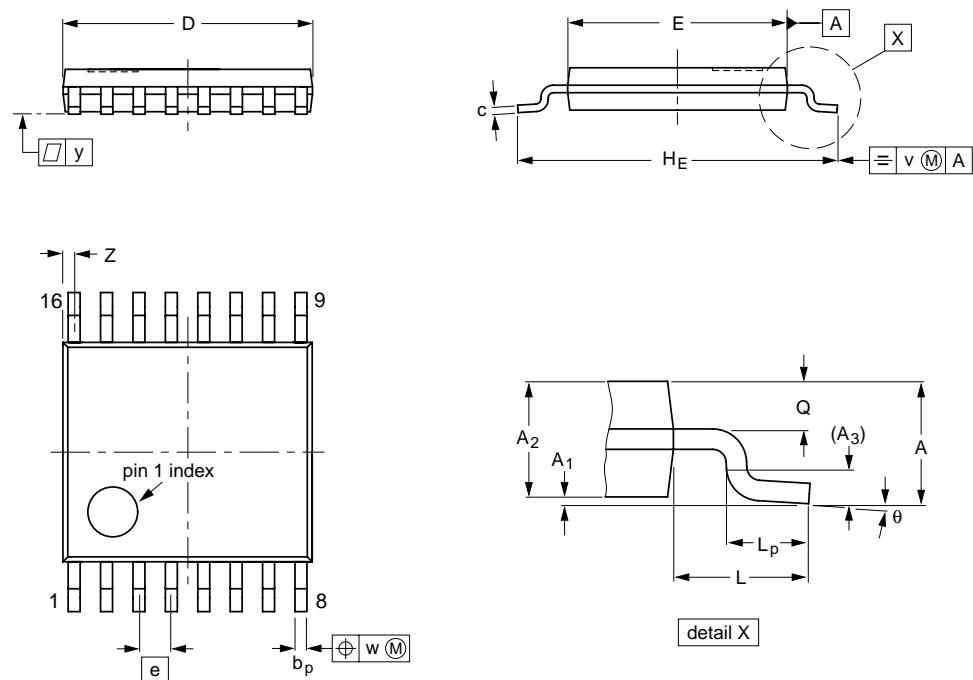

```
0        2.5        5 mm
|_|_|_|_|_|_|_|_|_|_|
        scale
```

DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A₁	A₂	A₃	bₚ	c	D (1)	E (2)	e	H_E	L	Lₚ	Q	v	w	y	Z (1)	θ
mm	1.10	0.15 0.05	0.95 0.80	0.25	0.30 0.19	0.2 0.1	5.1 4.9	4.5 4.3	0.65	6.6 6.2	1.0	0.75 0.50	0.4 0.3	0.2	0.13	0.1	0.40 0.06	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT403-1		MO-153				~~94-07-12~~ 95-04-04

Dual retriggerable monostable
multivibrator with reset

74HC/HCT123

SOLDERING

Introduction

There is no soldering method that is ideal for all IC
packages. Wave soldering is often preferred when
through-hole and surface mounted components are mixed
on one printed-circuit board. However, wave soldering is
not always suitable for surface mounted ICs, or for
printed-circuits with high population densities. In these
situations reflow soldering is often used.

This text gives a very brief insight to a complex technology.
A more in-depth account of soldering ICs can be found in
our *"Data Handbook IC26; Integrated Circuit Packages"*
(order code 9398 652 90011).

DIP

SOLDERING BY DIPPING OR BY WAVE

The maximum permissible temperature of the solder is
260 °C; solder at this temperature must not be in contact
with the joint for more than 5 seconds. The total contact
time of successive solder waves must not exceed
5 seconds.

The device may be mounted up to the seating plane, but
the temperature of the plastic body must not exceed the
specified maximum storage temperature ($T_{stg\ max}$). If the
printed-circuit board has been pre-heated, forced cooling
may be necessary immediately after soldering to keep the
temperature within the permissible limit.

REPAIRING SOLDERED JOINTS

Apply a low voltage soldering iron (less than 24 V) to the
lead(s) of the package, below the seating plane or not
more than 2 mm above it. If the temperature of the
soldering iron bit is less than 300 °C it may remain in
contact for up to 10 seconds. If the bit temperature is
between 300 and 400 °C, contact may be up to 5 seconds.

SO, SSOP and TSSOP

REFLOW SOLDERING

Reflow soldering techniques are suitable for all SO, SSOP
and TSSOP packages.

Reflow soldering requires solder paste (a suspension of
fine solder particles, flux and binding agent) to be applied
to the printed-circuit board by screen printing, stencilling or
pressure-syringe dispensing before package placement.

Several techniques exist for reflowing; for example,
thermal conduction by heated belt. Dwell times vary
between 50 and 300 seconds depending on heating
method.

Typical reflow temperatures range from 215 to 250 °C.
Preheating is necessary to dry the paste and evaporate
the binding agent. Preheating duration: 45 minutes at
45 °C.

WAVE SOLDERING

Wave soldering can be used for all SO packages. Wave
soldering is **not** recommended for SSOP and TSSOP
packages, because of the likelihood of solder bridging due
to closely-spaced leads and the possibility of incomplete
solder penetration in multi-lead devices.

If wave soldering is used - **and cannot be avoided for
SSOP and TSSOP packages** - the following conditions
must be observed:

- A double-wave (a turbulent wave with high upward
  pressure followed by a smooth laminar wave) soldering
  technique should be used.

- The longitudinal axis of the package footprint must be
  parallel to the solder flow and must incorporate solder
  thieves at the downstream end.

Even with these conditions:

- **Only consider wave soldering SSOP packages that
  have a body width of 4.4 mm, that is
  SSOP16 (SOT369-1) or SSOP20 (SOT266-1).**

- **Do not consider wave soldering TSSOP packages
  with 48 leads or more, that is TSSOP48 (SOT362-1)
  and TSSOP56 (SOT364-1).**

During placement and before soldering, the package must
be fixed with a droplet of adhesive. The adhesive can be
applied by screen printing, pin transfer or syringe
dispensing. The package can be soldered after the
adhesive is cured.

Maximum permissible solder temperature is 260 °C, and
maximum duration of package immersion in solder is
10 seconds, if cooled to less than 150 °C within
6 seconds. Typical dwell time is 4 seconds at 250 °C.

A mildly-activated flux will eliminate the need for removal
of corrosive residues in most applications.

Dual retriggerable monostable
multivibrator with reset

74HC/HCT123

REPAIRING SOLDERED JOINTS

Fix the component by first soldering two diagonally- opposite end leads. Use only a low voltage soldering iron (less than 24 V) applied to the flat part of the lead. Contact time must be limited to 10 seconds at up to 300 °C. When using a dedicated tool, all other leads can be soldered in one operation within 2 to 5 seconds between 270 and 320 °C.

DEFINITIONS

Data sheet status	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

LIFE SUPPORT APPLICATIONS

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.